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Kind regards,

Team Nexperia



Unidirectional ESD protection diodes Rev. 1 — 16 December 2010

Product data sheet

#### **Product profile** 1.

### 1.1 General description

Single unidirectional ElectroStatic Discharge (ESD) protection diodes in a SOD882 leadless ultra small Surface-Mounted Device (SMD) plastic package designed to protect one signal line from the damage caused by ESD and other transients.

### 1.2 Features and benefits

- ESD protection of one line
- Max. peak pulse power: P<sub>PP</sub> = 150 W
- Low clamping voltage: V<sub>CL</sub> = 10 V
- Ultra low leakage current: I<sub>RM</sub> = 3 nA
- AEC-Q101 qualified

### 1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories

### 1.4 Quick reference data

#### Table 1. Quick reference data

- $T_{amb} = 25 \ ^{\circ}C$  unless otherwise specified.
- Symbol Parameter Conditions Min Unit Тур Max V<sub>RWM</sub> reverse standoff voltage PESD9X5.0L 5.0 V -PESD9X7.0L V 7.0 -diode capacitance  $f = 1 MHz; V_R = 0 V$ Cd PESD9X5.0L 68 100 pF -PESD9X7.0L 62 pF 100 -

- ESD protection up to 30 kV
- IEC 61000-4-2; level 4 (ESD)
- IEC 61000-4-5 (surge); I<sub>PP</sub> = 10 A
- Ultra small SMD plastic package
- Portable electronics
- Communication systems



**Unidirectional ESD protection diodes** 

### 2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	cathode	<u>[1]</u>	
2	anode	1 2	1 2 006aaa152
		Transparent top view	

[1] The marking bar indicates the cathode.

### 3. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
PESD9X5.0L	-	leadless ultra small plastic package; 2 terminals;	SOD882		
PESD9X7.0L		body $1.0 \times 0.6 \times 0.5$ mm			

### 4. Marking

Table 4. Marking codes	
Type number	Marking code
PESD9X5.0L	AS
PESD9X7.0L	AT

### 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>PP</sub>	peak pulse power	$t_p = 8/20 \ \mu s$	<u>[1][2]</u> _	150	W
I <sub>PP</sub>	peak pulse current	$t_p = 8/20 \ \mu s$	<u>[1][2]</u> _	10	А
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Non-repetitive current pulse 8/20  $\mu$ s exponential decay waveform according to IEC 61000-4-5.

[2] Measured from pin 1 to pin 2.

#### **Unidirectional ESD protection diodes**

#### Table 6.ESD maximum ratings

 $T_{amb} = 25 \ ^{\circ}C$  unless otherwise specified.

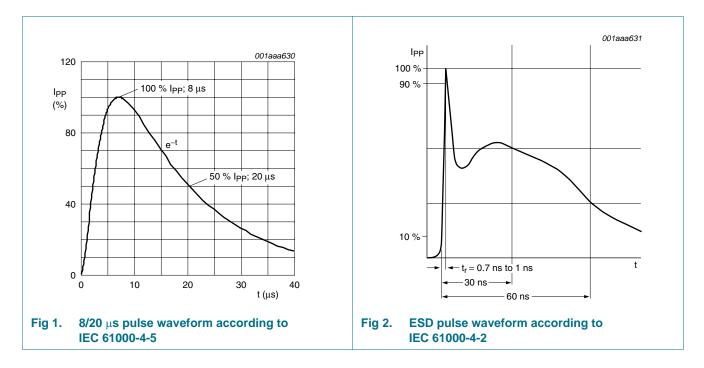
Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>ESD</sub>	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	<u>[1][2]</u>	-	30	kV
		machine model		-	400	V
		MIL-STD-883 (human body model)		-	10	kV

[1] Device stressed with ten non-repetitive ESD pulses.

[2] Measured from pin 1 to pin 2.

#### Table 7.ESD standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD)	> 15 kV (air); > 8 kV (contact)
MIL-STD-883; class 3 (human body model)	> 4 kV



**Unidirectional ESD protection diodes** 

### 6. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>RWM</sub>	reverse standoff voltage						
	PESD9X5.0L			-	-	5.0	V
	PESD9X7.0L			-	-	7.0	V
I <sub>RM</sub>	reverse leakage current						
	PESD9X5.0L	$V_{RWM} = 5.0 V$		-	3	100	nA
	PESD9X7.0L	$V_{RWM} = 7.0 V$		-	35	500	nA
V <sub>BR</sub>	breakdown voltage	I <sub>R</sub> = 1 mA					
	PESD9X5.0L			6.2	-	-	V
	PESD9X7.0L			7.5	-	-	V
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V					
	PESD9X5.0L			-	68	100	pF
	PESD9X7.0L			-	62	100	pF
V <sub>CL</sub>	clamping voltage		[1][2]				
	PESD9X5.0L	I <sub>PP</sub> = 10 A		-	-	18	V
		I <sub>PP</sub> = 1 A		-	-	10	V
	PESD9X7.0L	I <sub>PP</sub> = 10 A		-	-	18	V
		I <sub>PP</sub> = 1 A		-	-	11	V
r <sub>dyn</sub>	dynamic resistance	I <sub>R</sub> = 10 A	[2][3]	-	0.4	-	Ω

[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

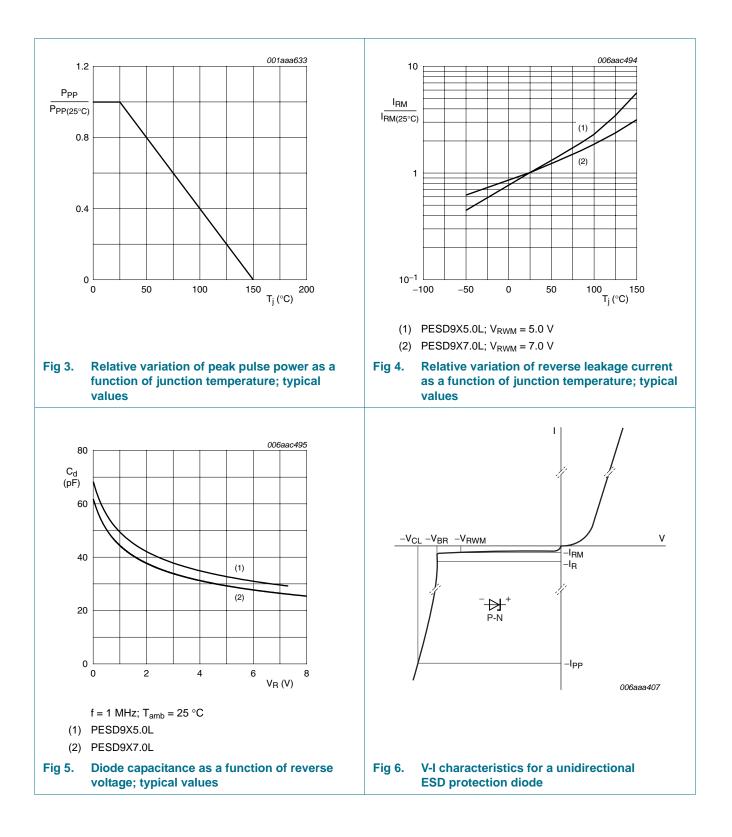
[2] Measured from pin 1 to pin 2.

[3] Non-repetitive current pulse; Transmission Line Pulse (TLP)  $t_p = 100$  ns; square pulse; ANSI/ESD STM5.1-2008.

### **NXP Semiconductors**

# PESD9X5.0L; PESD9X7.0L

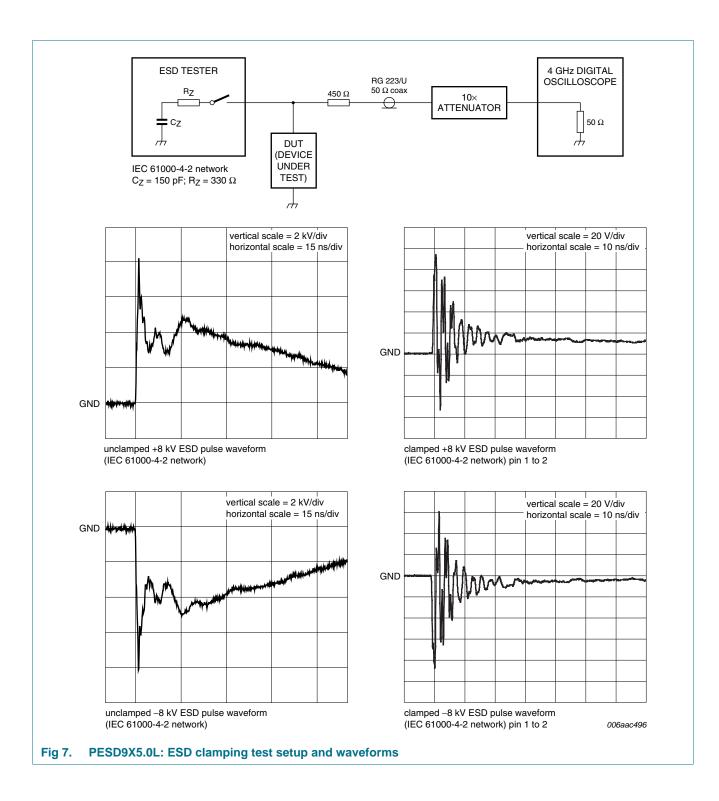
#### **Unidirectional ESD protection diodes**



### **NXP Semiconductors**

# PESD9X5.0L; PESD9X7.0L

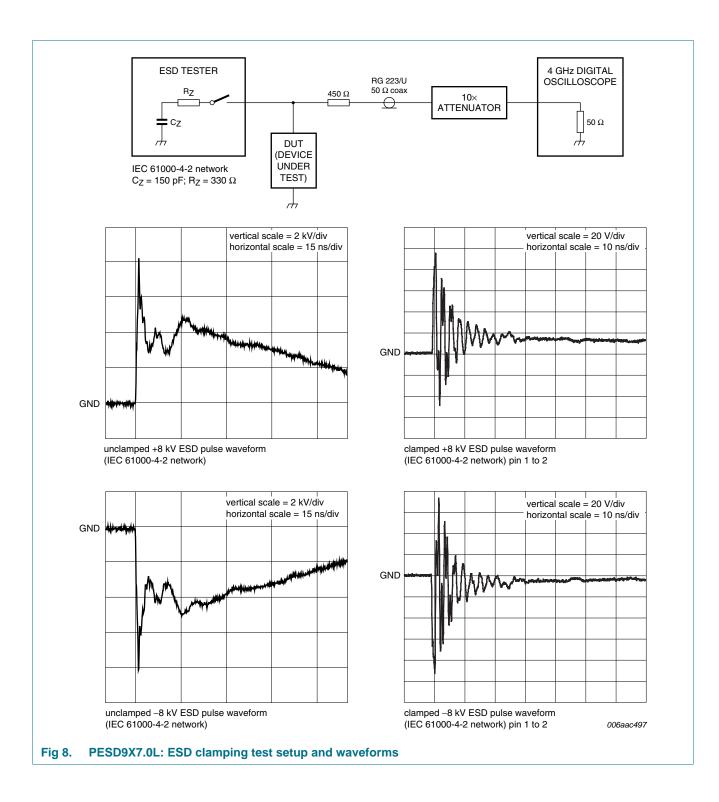
#### **Unidirectional ESD protection diodes**



### **NXP Semiconductors**

# PESD9X5.0L; PESD9X7.0L

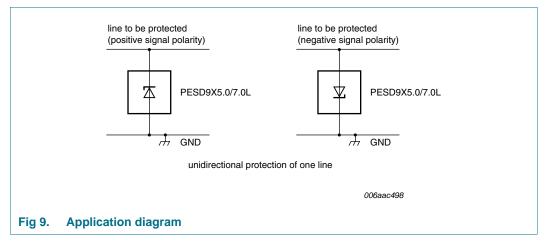
#### **Unidirectional ESD protection diodes**



**Unidirectional ESD protection diodes** 

### 7. Application information

The PESD9X5.0L and the PESD9X7.0L are designed for the protection of one unidirectional data or signal line from the damage caused by ESD and surge pulses. Both devices may be used on lines where the signal polarities are either positive or negative with respect to ground. The devices provide a surge capability of 150 W per line for an 8/20  $\mu$ s waveform.



#### Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

- 1. Place the device as close to the input terminal or connector as possible.
- 2. The path length between the device and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

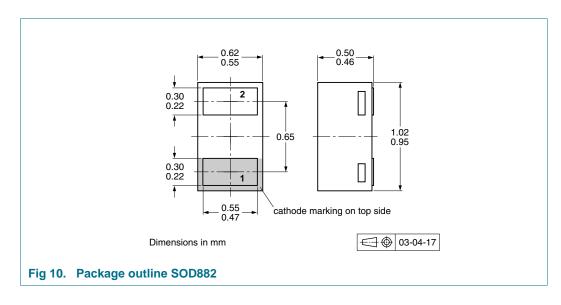
### 8. Test information

#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

**Unidirectional ESD protection diodes** 

### 9. Package outline



# **10. Packing information**

#### Table 9. Packing methods

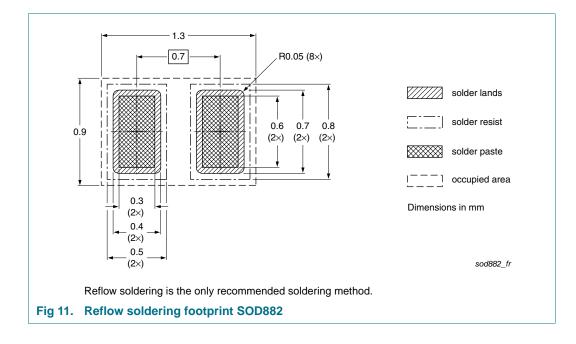
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity 10000
PESD9X5.0L	SOD882	2 mm pitch, 8 mm tape and reel	-315
PESD9X7.0L			

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

**Unidirectional ESD protection diodes** 

### **11. Soldering**



Unidirectional ESD protection diodes

# **12. Revision history**

Table 10. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
PESD9XXL_SER v.1	20101216	Product data sheet	-	-

**Unidirectional ESD protection diodes** 

### 13. Legal information

### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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### Unidirectional ESD protection diodes

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**Unidirectional ESD protection diodes** 

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